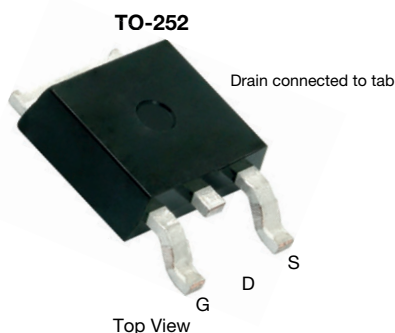


Automotive N-Channel 250 V (D-S) 175 °C MOSFET

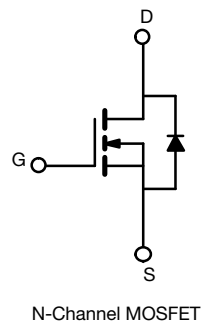


FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization:
for definitions of compliance please see
www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE



PRODUCT SUMMARY

V _{DS} (V)	250
R _{DS(on)} (Ω) at V _{GS} = 10 V	0.1620
R _{DS(on)} (Ω) at V _{GS} = 7.5 V	0.1800
I _D (A)	11.5
Configuration	Single
Package	TO-252

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	250	V
Gate-source voltage	V _{GS}	± 20	
Continuous drain current	I _D	T _C = 25 °C	A
		T _C = 125 °C	
Continuous source current (diode conduction) ^a	I _S	50	
Pulsed drain current ^b	I _{DM}	30	
Single pulse avalanche current	I _{AS}	10	mJ
Single pulse avalanche energy	E _{AS}	5	
Maximum power dissipation ^b	P _D	T _C = 25 °C	W
		T _C = 125 °C	
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient	R _{thJA}	50	°C/W
Junction-to-case (drain)	R _{thJC}	2.4	

Notes

- Package limited
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)

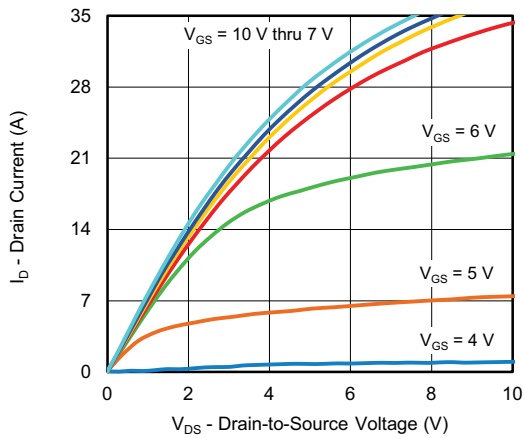
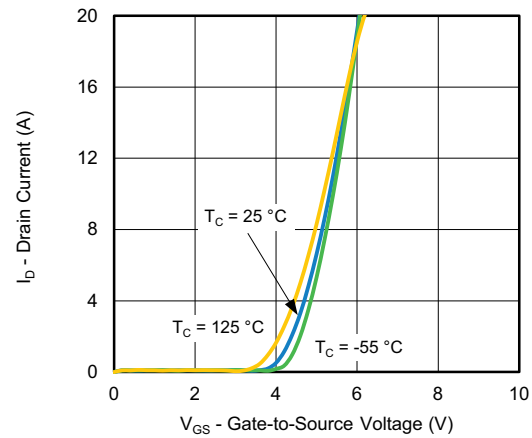
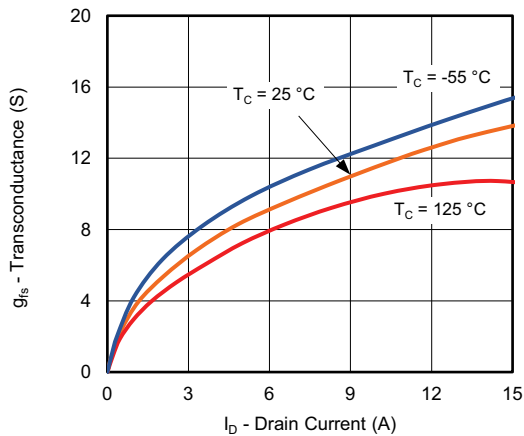
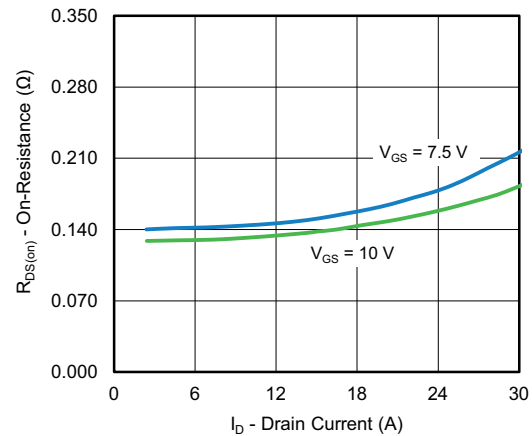
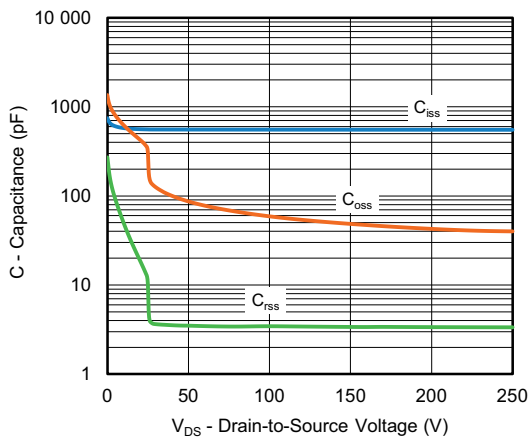
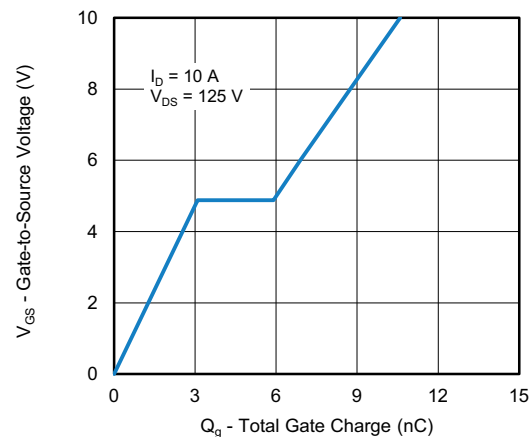


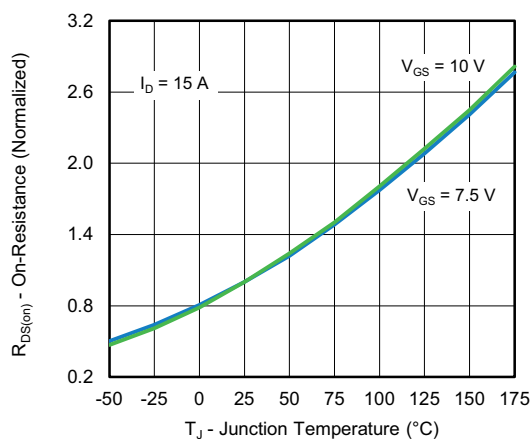
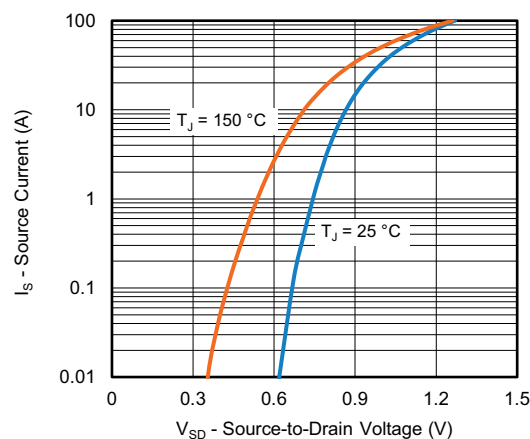
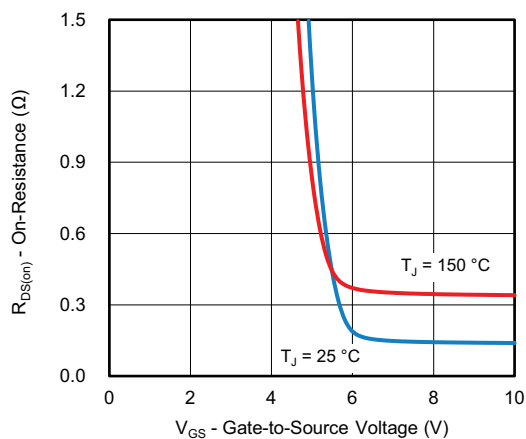
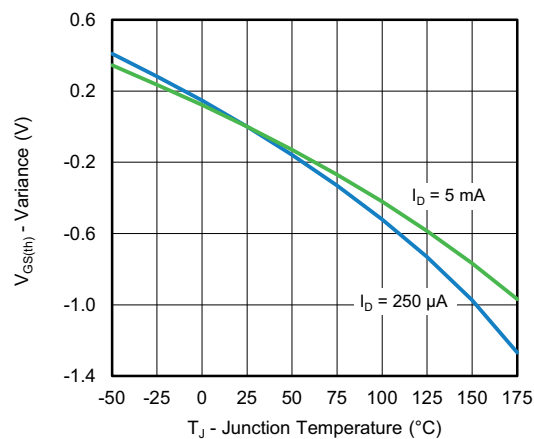
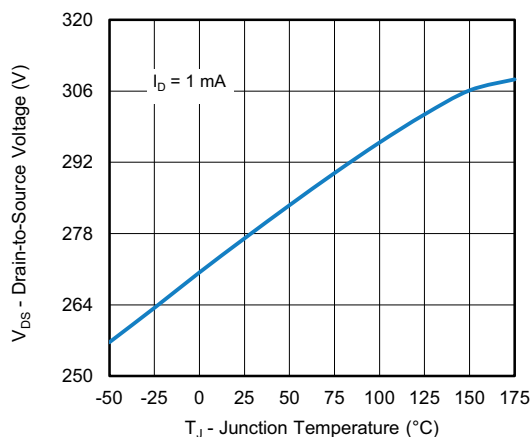
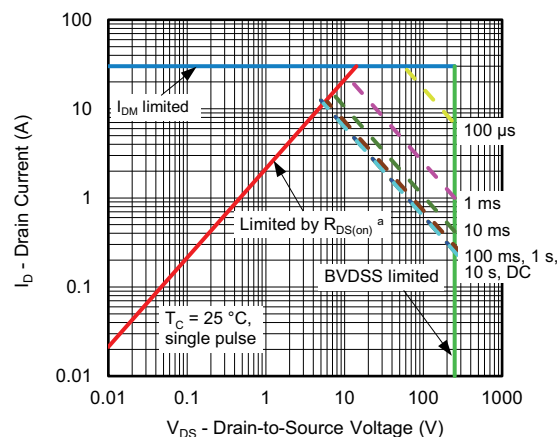
SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		250	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		2.5	3.0	3.5	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V		-	-	± 100	
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 250 V	-	-	1	μA
		V _{GS} = 0 V	V _{DS} = 250 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 250 V, T _J = 175 °C	-	-	250	μA
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	12	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.1342	0.1620	Ω
		V _{GS} = 7.5 V	I _D = 10 A	-	0.1443	0.1800	
		V _{GS} = 10 V	I _D = 12 A, T _J = 125 °C	-	-	0.3437	
		V _{GS} = 10 V	I _D = 12 A, T _J = 175 °C	-	-	0.4560	
Forward transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 12 A		-	12	-	S
Dynamic ^b							
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 25 V, f = 1 MHz	-	558	785	pF
Output capacitance	C _{oss}			-	308	435	
Reverse transfer capacitance	C _{rss}			-	11	16	
Total gate charge ^c	Q _g	V _{GS} = 10 V	V _{DS} = 125 V, I _D = 10 A	-	10.6	16	nC
Gate-source charge ^c	Q _{gs}			-	3.1	-	
Gate-drain charge ^c	Q _{gd}			-	2.8	-	
Gate resistance	R _g	f = 1 MHz		1.9	3.8	5.7	Ω
Turn-on delay time ^c	t _{d(on)}	V _{DD} = 125 V, R _L = 12.5 Ω I _D ≅ 10 A, V _{GEN} = 10 V, R _g = 1 Ω		-	8	20	ns
Rise time ^c	t _r			-	3	10	
Turn-off delay time ^c	t _{d(off)}			-	15	30	
Fall time ^c	t _f			-	3	10	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed current ^a	I _{SM}			-	-	30	A
Forward voltage	V _{SD}	I _F = 15 A, V _{GS} = 0 V		-	0.9	1.5	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	127	260	ns
Body diode reverse recovery charge	Q _{rr}			-	583	1170	nC
Reverse recovery fall time	t _a			-	88	-	ns
Reverse recovery rise time	t _b			-	39	-	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-8.6	-	A

Notes

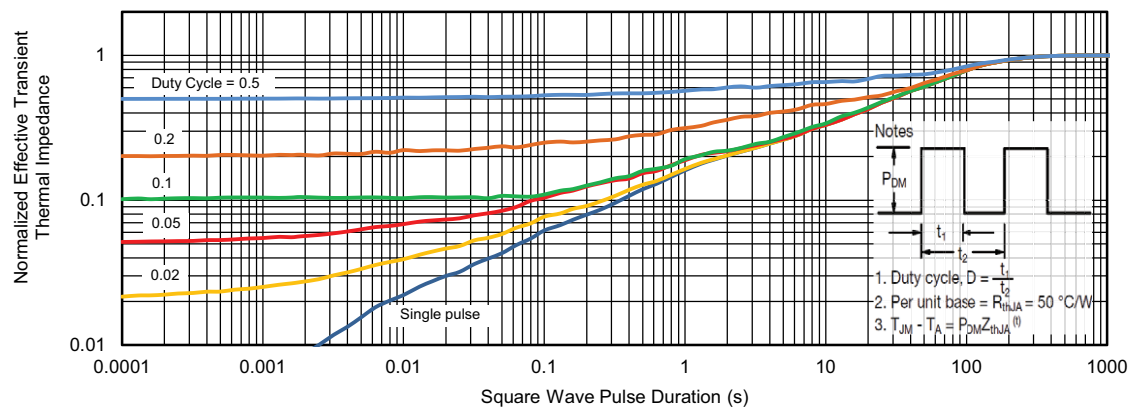
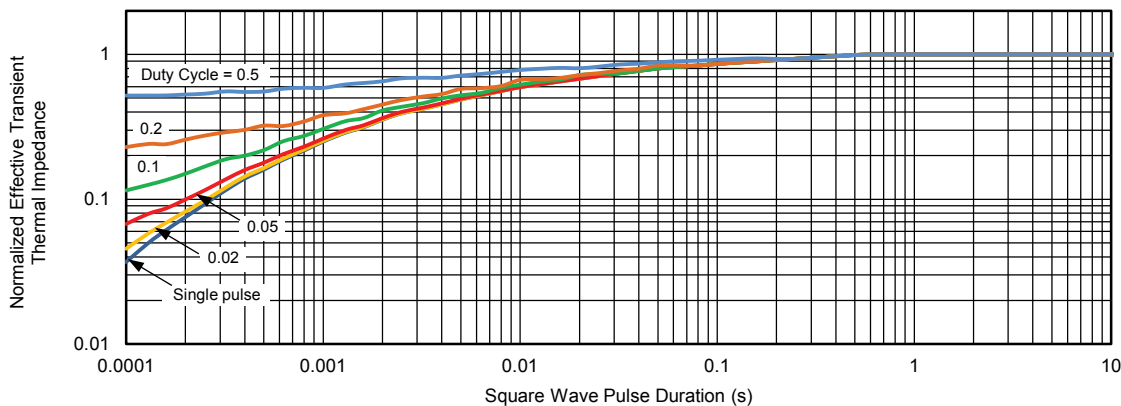
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Output Characteristics

Transfer Characteristics

Transconductance

On-Resistance vs. Drain Current

Capacitance

Gate Charge

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

On-Resistance vs. Junction Temperature

Source Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Drain Source Breakdown vs. Junction Temperature

Safe Operating Area
Note

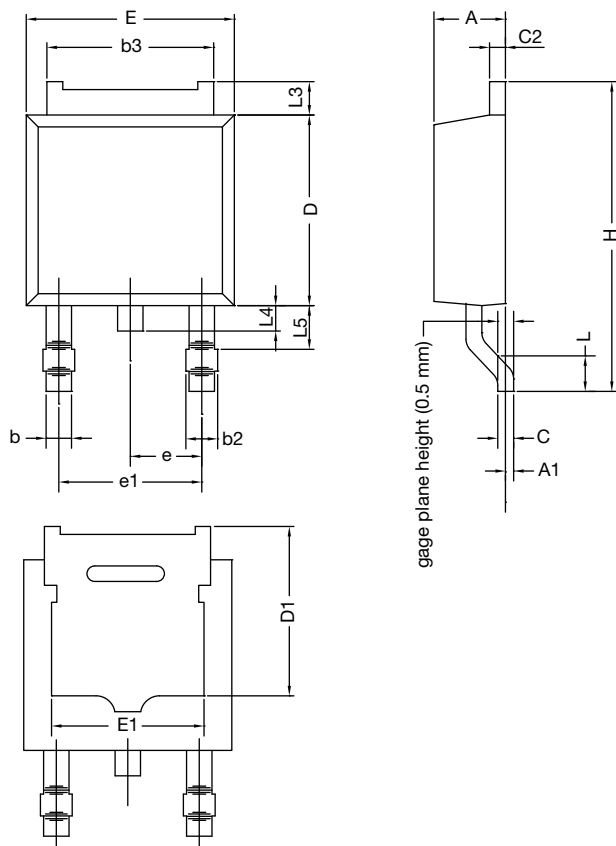
a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

**THERMAL RATINGS** ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Case****Note**

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^{\circ}\text{C}$)
- are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?79721.

TO-252AA Case Outline



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
C	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
H	9.40	10.41	0.370	0.410
e	2.28 BSC		0.090 BSC	
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060
ECN: T13-0592-Rev. A, 02-Sep-13 DWG: 6019				

Note

- Dimension L3 is for reference only.

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads
Dimensions in Inches/(mm)

[Return to Index](#)



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